



US00D444085S

(12) **United States Design Patent** (10) **Patent No.:** **US D444,085 S**
Wrisley et al. (45) **Date of Patent:** **** *Jun. 26, 2001**

(54) **PROCESSOR AND DISPLAY MODULE FOR
A MODULAR MEASUREMENT
INSTRUMENT**

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(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **14 Years**

(21) Appl. No.: **29/120,013**

(22) Filed: **Mar. 13, 2000**

(51) **LOC (7) Cl.** **10-04**

(52) **U.S. Cl.** **D10/78**

(58) **Field of Search** D10/46, 75, 78,
D10/81; D14/100; 73/336.5, 431; 128/630,
745, 746; 340/573.1, 573.3, 601, 576, 521;
600/301, 300, 368; 364/413.02, 413.07-413.09;
324/158

(56) **References Cited**

U.S. PATENT DOCUMENTS

D. 383,400 * 9/1997 Wada D10/65
D. 412,156 * 7/1999 Mizusugi et al. D14/100
5,410,474 * 4/1995 Fox 600/300
6,111,501 * 8/2000 Honeyager et al. 340/521

* cited by examiner

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(57) **CLAIM**

The ornamental design for a processor and display module for a modular measurement instrument, as shown and described.

DESCRIPTION

The ornamental design disclosed in this application is for a processor and display module for a modular measurement instrument having raised bumper guards at the corners of the module, a bi-level rear surface, an array of raised protrusions on the right and left sides of the display screen, an array of ribs formed on the left side of the instrument and extending onto the top and bottom surfaces with the top surface ribs terminating adjacent to the array of raised protrusions, and array of raised protrusions on the rear surface of the instrument adjacent to the ribs.

FIG. 1 is a perspective view of a processor and display module for a modular measurement instrument;

FIG. 2 is a front elevation view of the processor and display module for a modular measurement instrument;

FIG. 3 is a rear elevation view of the processor and display module for a modular measurement instrument;

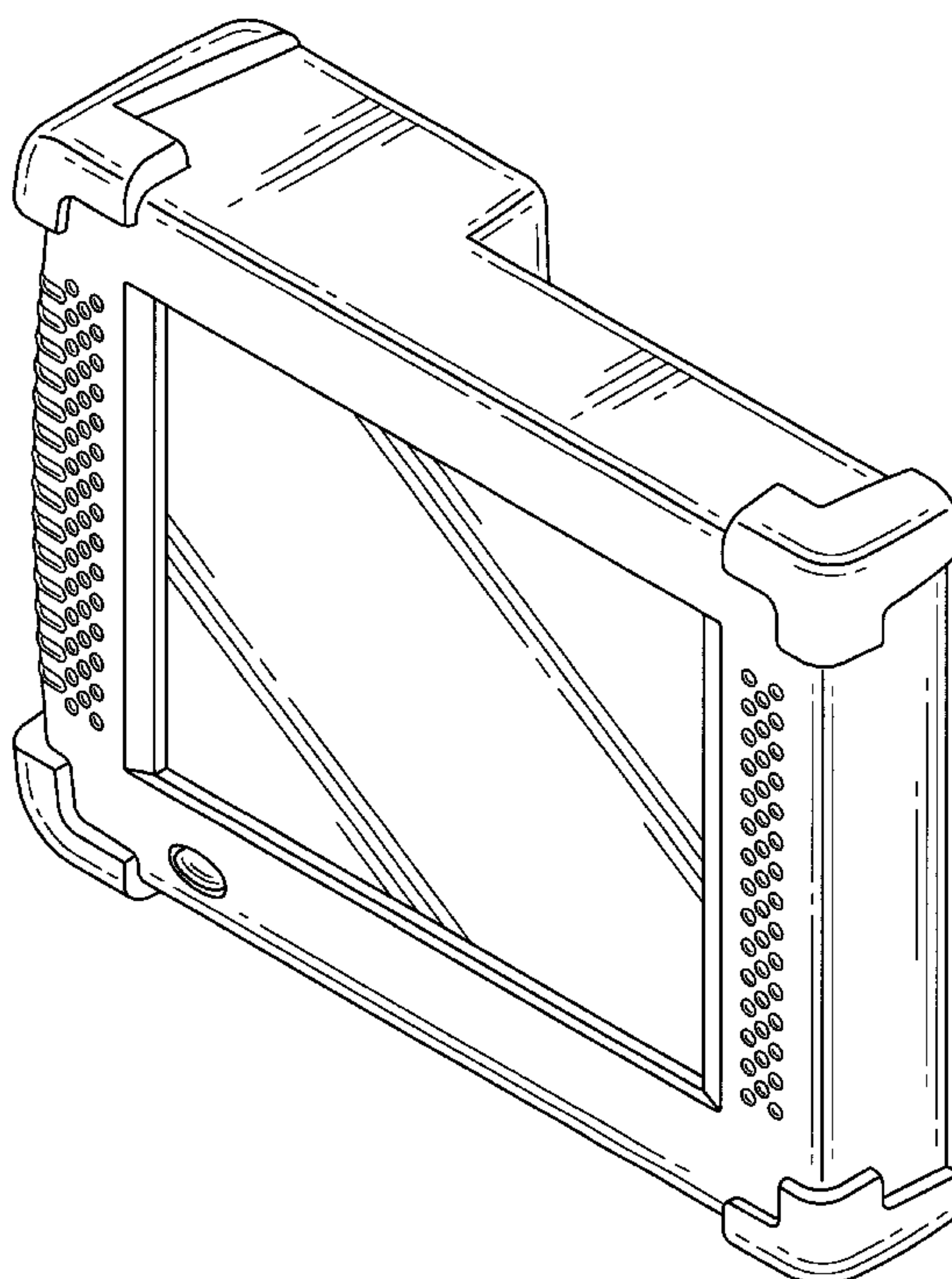
FIG. 4 is a left side elevation view of the processor and display module for a modular measurement instrument;

FIG. 5 is a right side elevation view of the processor and display module for a modular measurement instrument.

FIG. 6 is a top plan view of the processor and display module for a modular measurement instrument; and,

FIG. 7 is a bottom plan view of the processor and display module for a modular measurement instrument.

1 Claim, 5 Drawing Sheets



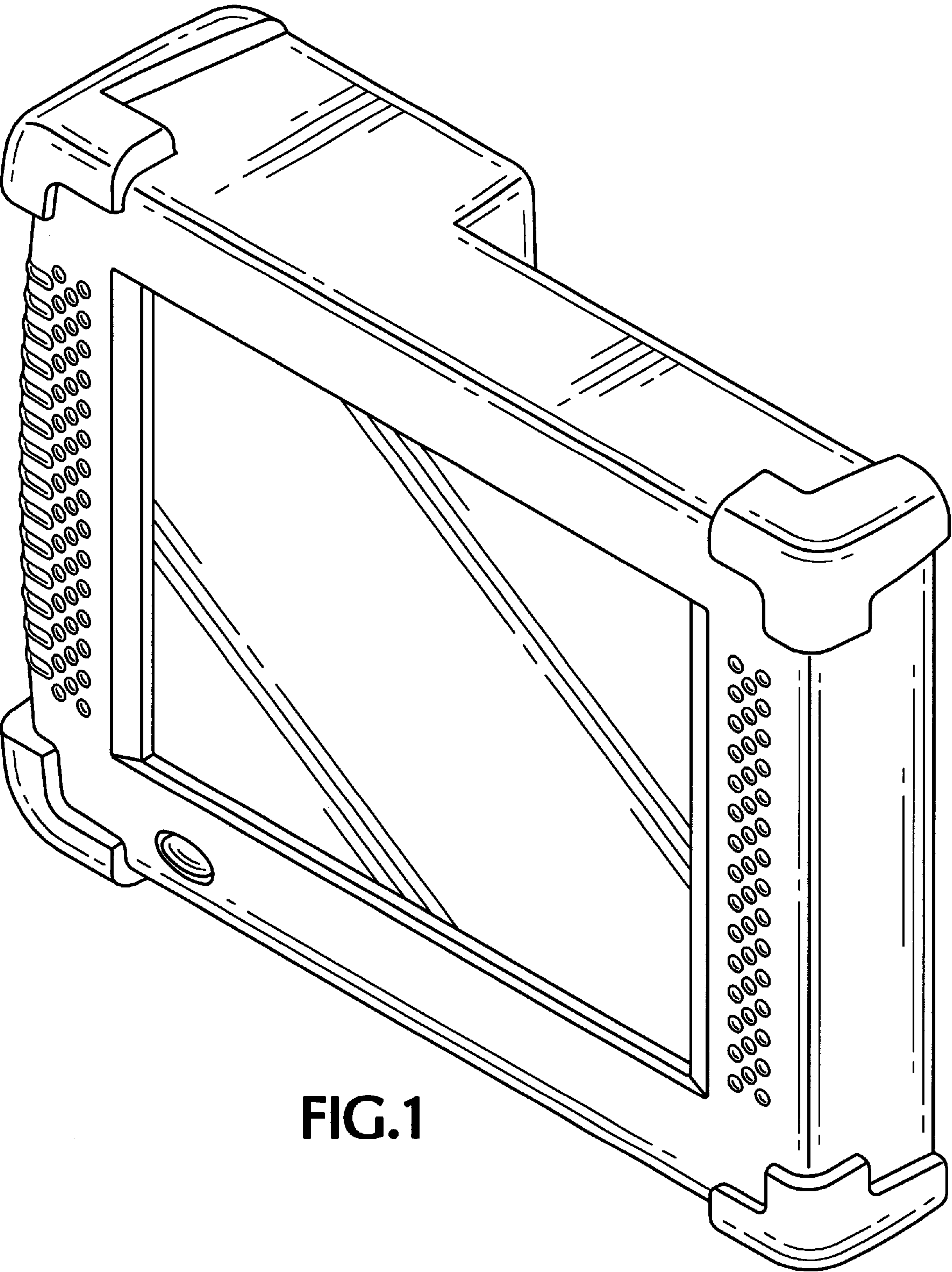


FIG.1

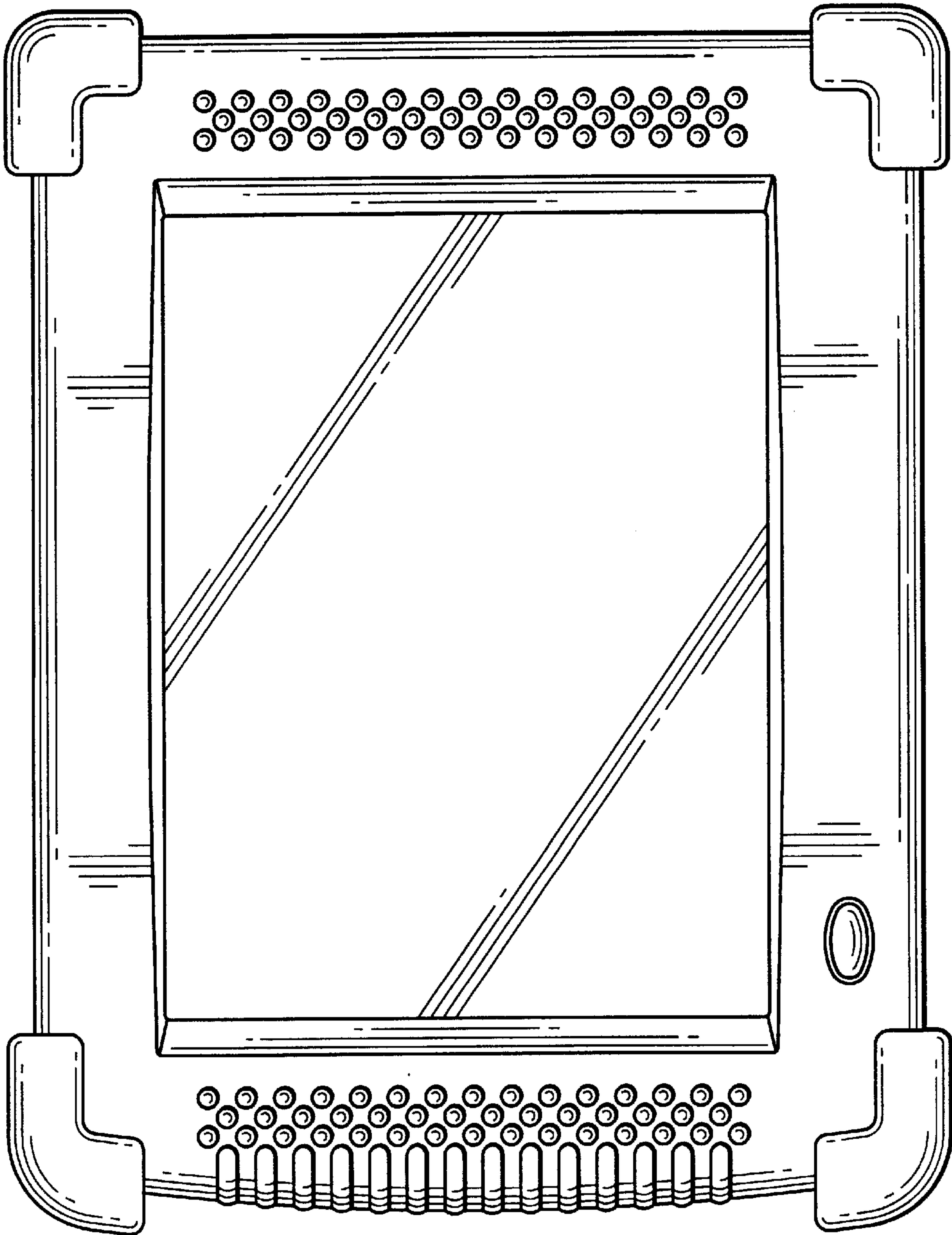


FIG.2

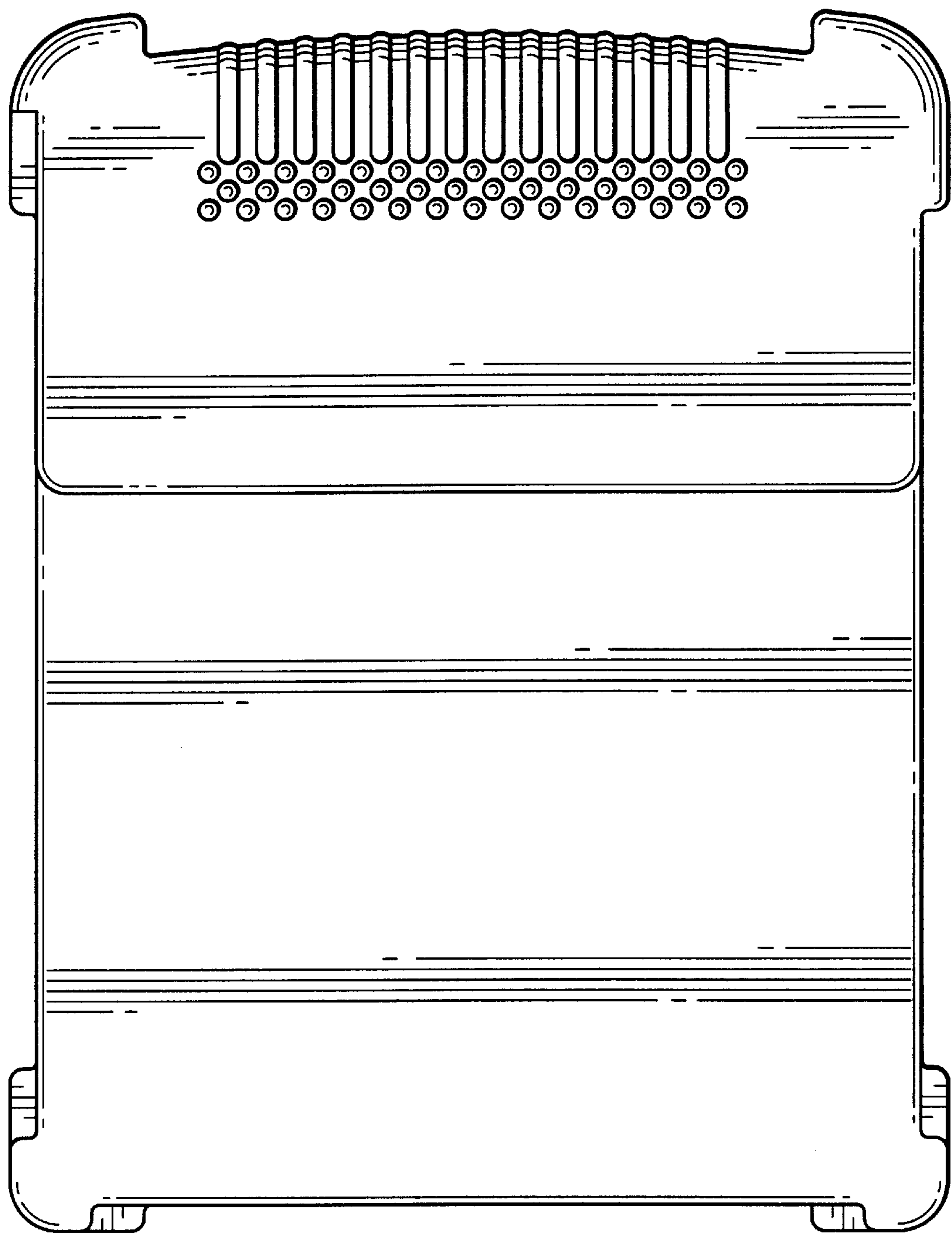


FIG.3

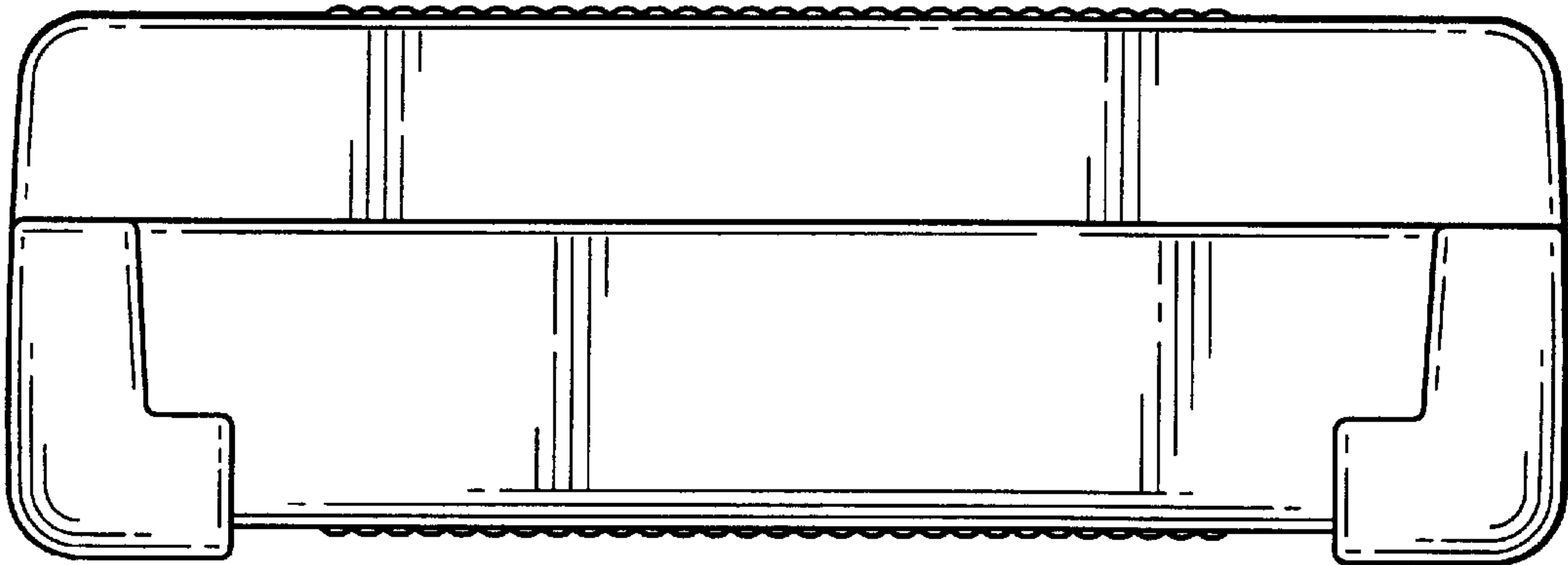


FIG. 5

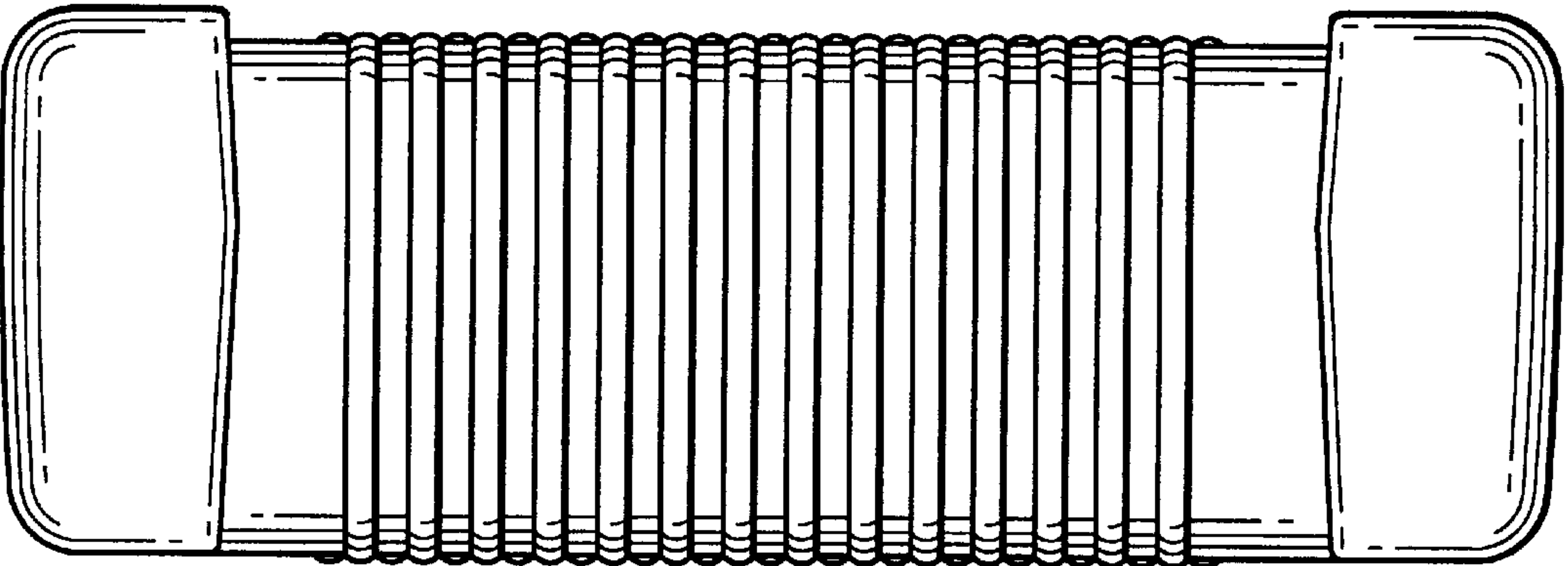


FIG. 4

FIG.6

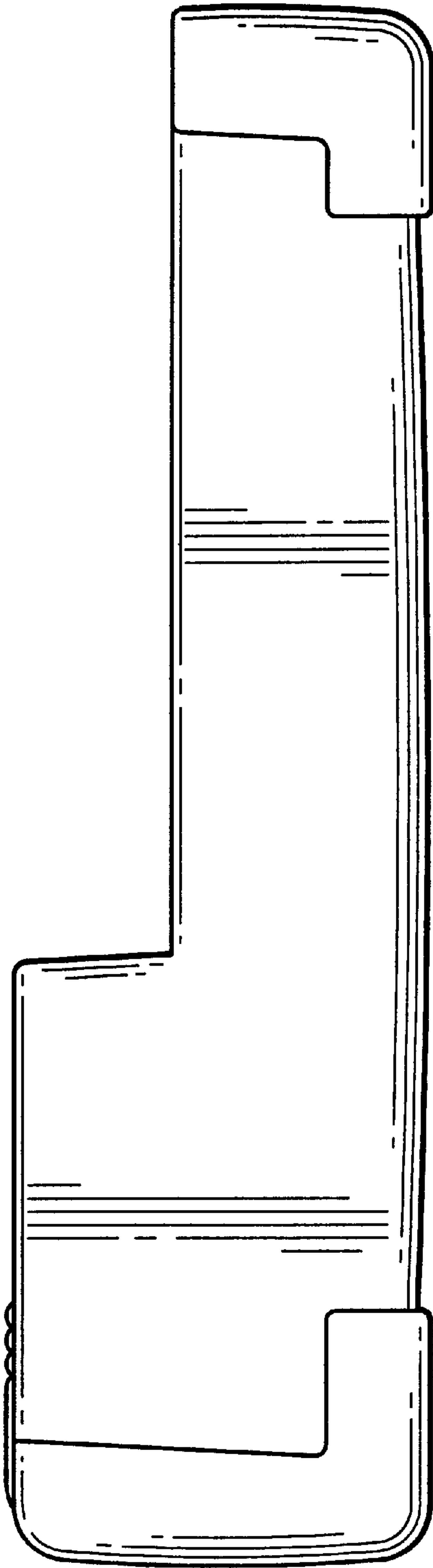


FIG.7

